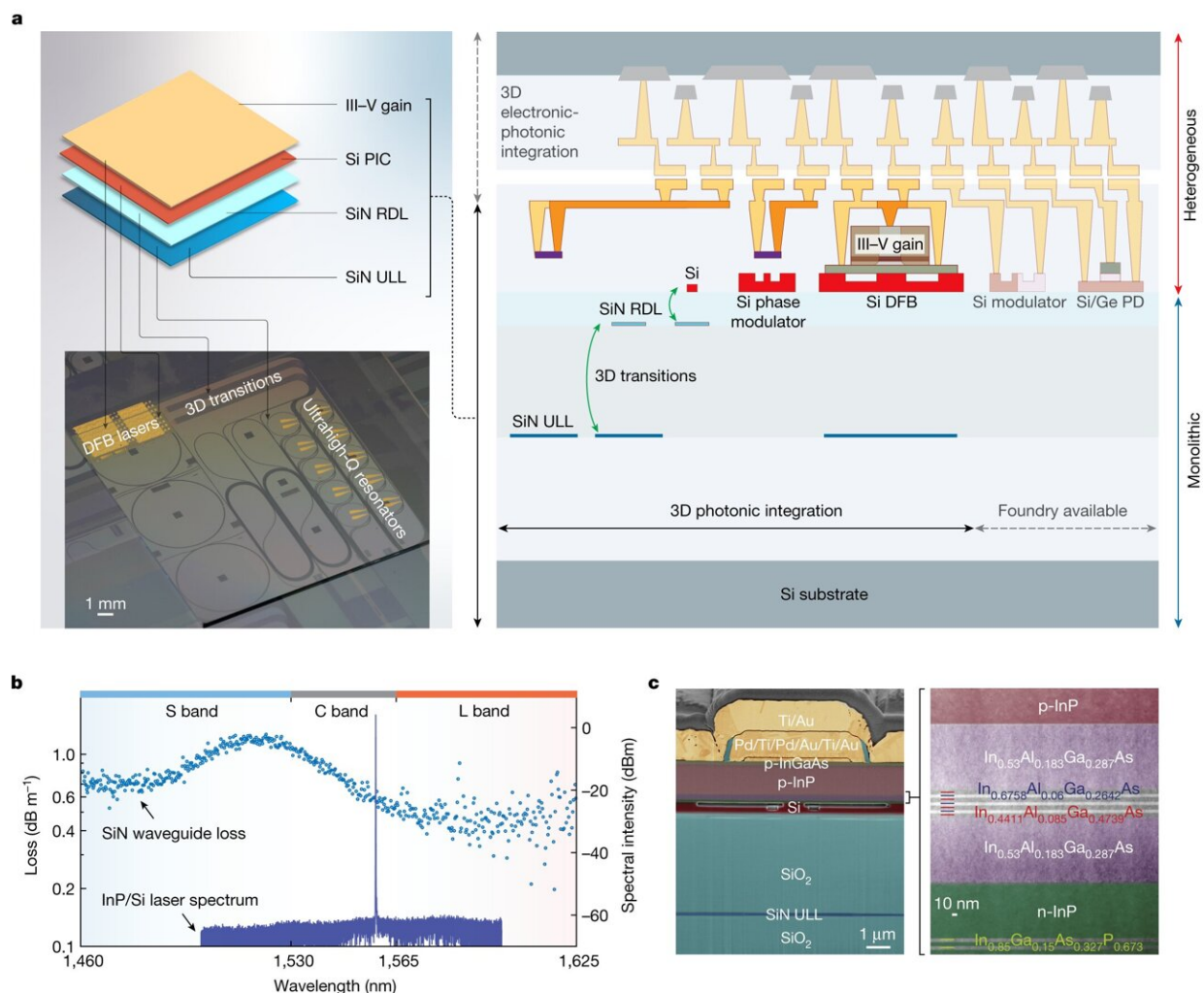


A first-of-its-kind chip features both a laser and waveguide to create a photonic integrated circuit

August 9 2023, by Bob Yirka



3D integrated Si PIC chip. a, Left: concept of 3D photonic integration of functional layers (top) and the corresponding devices on a fabricated 3D PIC

(device picture shown in the bottom). This chip is singulated from a fully fabricated 100-mm-diameter wafer. The SiN wafer process is performed on a 200-mm-diameter wafer fabricated in a CMOS foundry, which was later cored into 100-mm-diameter wafers for heterogeneous laser fabrication. Right: the cross-section of the demonstrated 3D PIC in solid colours. We envision that future works will enable additional functionality, such as integration with foundry-available Si modulators and Ge/Si PDs, and 3D electronic–photonic heterogeneous integration, which are shown in transparent colors. Both monolithic and heterogeneous integration processes are employed, in which 3D transitions are critical to the vertical integration of functionality layers. b, Measured III–V/Si DFB laser spectrum centered at the telecom C band on the 3D PIC (right axis) and measured ULL SiN waveguide loss (left axis, extracted from the fitted resonator Q) across the telecom S, C and L bands on the same 3D PIC. c, Left: false-colored focused ion beam scanning electron microscopy image of the fabricated 3D PIC showing the laser cross-section. Right: transmission electron microscopy image showing the layered InP epitaxial stack after bonding and substrate removal. Credit: *Nature* (2023). DOI: 10.1038/s41586-023-06251-w

A team of computer and electrical engineers at the University of California, Santa Barbara, working with several colleagues from California Institute of Technology and another pair from Anello Photonics has developed a first-of-its-kind chip that hosts both a laser and a photonic wave guide. In their paper published in the journal *Nature*, the group describes how they made the chip and how well it worked when tested.

With the advent of the integrated circuit, scientists learned to put transistors, diodes and other components on a [single chip](#), greatly increasing their potential. Over the past several years, researchers working with photonics have hoped to achieve the same feat. Those in the field have suggested that the development of an analogous photonic [chip](#) could lead to more precise experiments with [atomic clocks](#) and

could also be used in quantum applications. It would also reduce the need for huge optical tables.

For such a chip to work, it would have to house both a laser and a photonic waveguide. To that end, engineers had developed insert isolators to prevent reflections that lead to instabilities that occur without them. Unfortunately, such an approach requires the use of magnetics, which leads to problems in production. In this new effort, the research team found a way to overcome these problems to create the first truly usable combined chip.

To create the chip, the researchers started by putting an ultralow-loss silicon nitride waveguide on a silicon substrate. They then covered the waveguide with multiple applications of silicon over which they mounted a low-noise indium phosphate laser. By separating the two components, the team prevented damage to the waveguide during etching.

The team notes that separating the two components also required the use of a redistribution layer made of silicon nitride to allow for interactions between the two components via evanescent fields. The distance created between the two components by the silicon layers minimizes interference.

The researchers tested their chip by first measuring its [noise levels](#). Finding them satisfactory, they then used it to create a tunable microwave frequency generator. They describe their chip as "a critical step towards complex systems and networks on [silicon](#)."

More information: Chao Xiang et al, 3D integration enables ultralow-noise isolator-free lasers in silicon photonics, *Nature* (2023). [DOI: 10.1038/s41586-023-06251-w](https://doi.org/10.1038/s41586-023-06251-w)

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Citation: A first-of-its-kind chip features both a laser and waveguide to create a photonic integrated circuit (2023, August 9) retrieved 4 October 2025 from

<https://phys.org/news/2023-08-first-of-its-kind-chip-features-laser-waveguide.html>

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